

# Chip Beads(SMD) For Signal Line

Conformity to RoHS Directive

## MMZ Series MMZ1608 Type

### FEATURES

- Chip bead(impeder), MMZ series offers 7 construction materials.
- Size standardized for use by automatic assembly equipment.  
No preferred orientation.
- Either flow or reflow soldering methods can be used due to electroplating of the terminal electrodes.
- High reliability due to an entirely monolithic structure.
- Closed magnetic circuit structure allows high-density installation while preventing crosstalk between circuits.
- Low DC resistance structure of electrode prevents wasteful electric power consumption.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

### APPLICATIONS

Removal of signal line noises of cellular phones, PCs, note PCs, TVs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, car navigation system, PNDs, etc.

### PRODUCT IDENTIFICATION

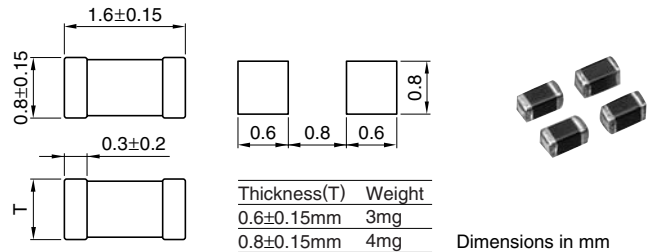
MMZ	1608	R	121	A	T
(1)	(2)	(3)	(4)	(5)	(6)

- (1) Series name
- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance  
121:120Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style  
T:Taping

### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

### SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



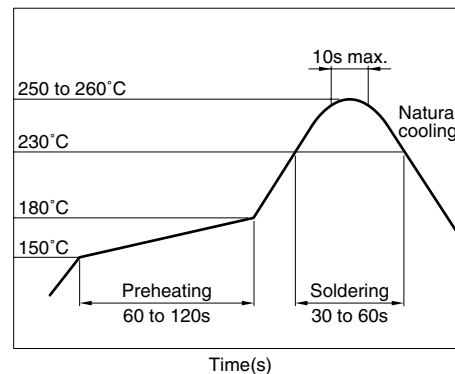
### TEMPERATURE RANGES

Operating/storage	-55 to +125°C
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### PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	4000 pieces/reel

### RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

• Please contact our Sales office when your application are considered the following:  
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

• All specifications are subject to change without notice.

## MATERIAL CHARACTERISTICS

**B material:** This type is perfectly suited for fast digital signals.

By equalizing R components and X components that beads possess at a frequency of 5MHz, it is able to suppress overshooting, undershooting and ringing of fast digital signals.

**R material:** For wide frequency applications calling for broad impedance characteristics.

For digital signal line applications calling requiring good waveform integrity. Impedance values selected for effectiveness at 10 to 200MHz.

**S material:** Standard type that features impedance characteristics similar to those of a typical ferrite core.

For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

**Y material:** High frequency range type intended for the 100MHz region and above.

For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

**A material:** This high-impedance product is based on the impedance frequency characteristics of our Y-material. The product offers excellent impedance characteristics, which is greater than 2500Ω in the vicinity of 100MHz range (MMZ1608A252B).

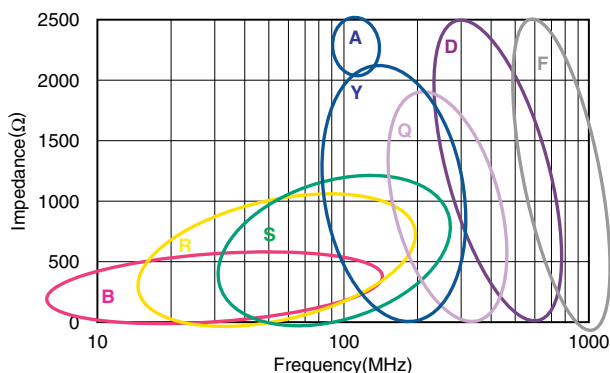
**Q material:** For high-band applications designed for 100MHz and above. Impedance values selected for effectiveness at 100 to 800MHz.

**D material:** For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies. Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

**F material:** This new product inherits the characteristic of our D-material, namely its sharp impedance rise time, and its impedance peak frequency has been shifted higher into range.

The product offers excellent noise suppression from 600MHz to as high as in the GHz range.

## TYPICAL MATERIAL CHARACTERISTICS



## ELECTRICAL CHARACTERISTICS

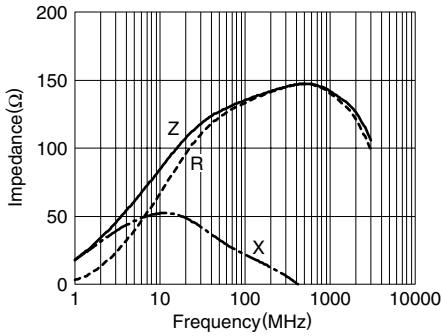
Part No.	Impedance (Ω) [100MHz]*	DC resistance (Ω)max.	Rated current (mA)max.	Product's thickness T(mm)
MMZ1608B121C	120±25%	0.15	600	0.6
MMZ1608B221C	220±25%	0.25	500	0.6
MMZ1608B301C	300±25%	0.25	500	0.6
MMZ1608B471C	470±25%	0.30	500	0.6
MMZ1608B601C	600±25%	0.40	500	0.6
MMZ1608B102C	1000±25%	0.60	300	0.8
MMZ1608R150A	15±25%	0.05	1500	0.8
MMZ1608R300A	30±25%	0.05	1500	0.8
MMZ1608R600A	60±25%	0.10	800	0.8
MMZ1608R121A	120±25%	0.18	500	0.8
MMZ1608R301A	300±25%	0.25	500	0.8
MMZ1608R471A	470±25%	0.30	500	0.8
MMZ1608R601A	600±25%	0.40	500	0.8
MMZ1608R102A	1000±25%	0.50	400	0.8
MMZ1608S400A	40±25%	0.10	600	0.8
MMZ1608S800A	80±25%	0.15	500	0.8
MMZ1608S121A	120±25%	0.15	500	0.8
MMZ1608S181A	180±25%	0.20	500	0.8
MMZ1608S221A	220±25%	0.20	500	0.8
MMZ1608S301A	300±25%	0.30	500	0.8
MMZ1608S471A	470±25%	0.30	500	0.8
MMZ1608S601A	600±25%	0.35	500	0.8
MMZ1608S102A	1000±25%	0.50	400	0.8
MMZ1608S202A	2000±25%	0.90	200	0.8
MMZ1608Y150B	15±25%	0.05	1500	0.8
MMZ1608Y300B	30±25%	0.05	1500	0.8
MMZ1608Y600B	60±25%	0.15	500	0.8
MMZ1608Y121B	120±25%	0.20	500	0.8
MMZ1608Y221B	220±25%	0.30	500	0.8
MMZ1608Y301B	300±25%	0.30	500	0.8
MMZ1608Y471B	470±25%	0.35	500	0.8
MMZ1608Y601B	600±25%	0.40	500	0.8
MMZ1608Y751B	750±25%	0.45	500	0.8
MMZ1608Y102B	1000±25%	0.50	400	0.8
MMZ1608Y152B	1500±25%	0.60	300	0.8
MMZ1608A182B	1800±25%	0.80	200	0.8
MMZ1608A222B	2200±25%	0.80	200	0.8
MMZ1608A252B	2500±25%	0.80	200	0.8
MMZ1608Q121B	120±25%	0.30	500	0.8
MMZ1608Q221B	220±25%	0.40	500	0.8
MMZ1608Q331B	330±25%	0.50	400	0.8
MMZ1608Q471B	470±25%	0.70	300	0.8
MMZ1608Q601B	600±25%	0.80	200	0.8
MMZ1608Q102B	1000±25%	1.00	200	0.8
MMZ1608D050C	5±2Ω	0.05	700	0.8
MMZ1608D100C	10±5Ω	0.10	500	0.6
MMZ1608D220C	22±25%	0.20	500	0.6
MMZ1608D500C	50±25%	0.25	500	0.6
MMZ1608D800C	80±25%	0.30	500	0.6
MMZ1608D800B	80±25%	0.30	500	0.8
MMZ1608D121C	120±25%	0.30	400	0.6
MMZ1608D121B	120±25%	0.30	400	0.8
MMZ1608D241C	240±25%	0.60	300	0.8
MMZ1608D301B	300±25%	0.70	300	0.8
MMZ1608F030B	3typ.	0.05	700	0.8
MMZ1608F470B	47±25%	0.40	500	0.8
MMZ1608F750B	75±25%	0.55	300	0.8
MMZ1608F121B	120±25%	0.75	200	0.8

\* Test equipment: E4991A or equivalent

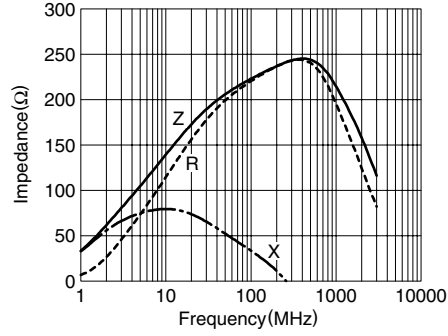
Test tool: 16192A or equivalent

Test temperature: 25±10°C

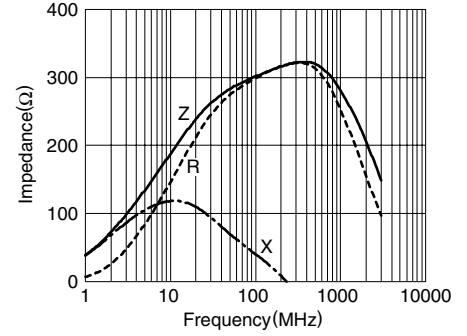
**TYPICAL ELECTRICAL CHARACTERISTICS**  
**Z, X, R vs. FREQUENCY CHARACTERISTICS**  
**MMZ1608B121C**



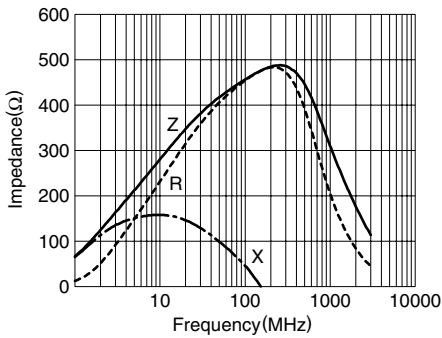
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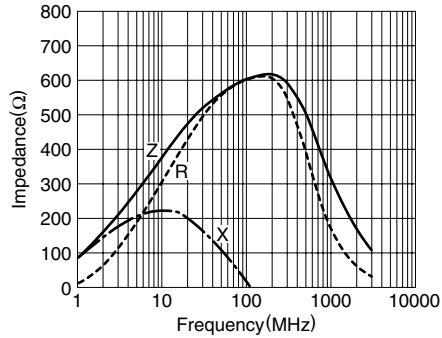
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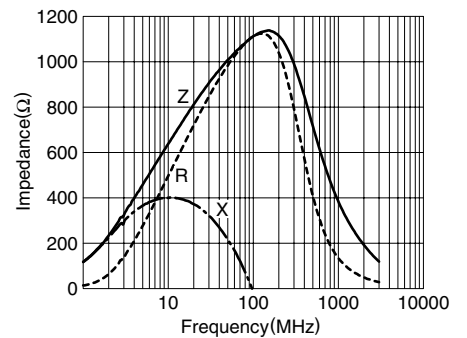
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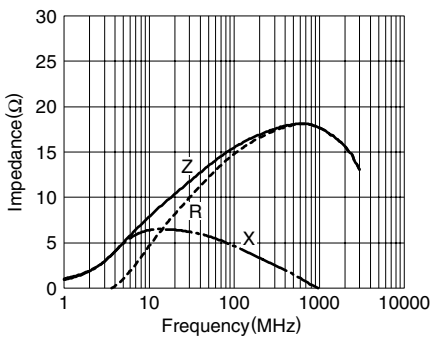
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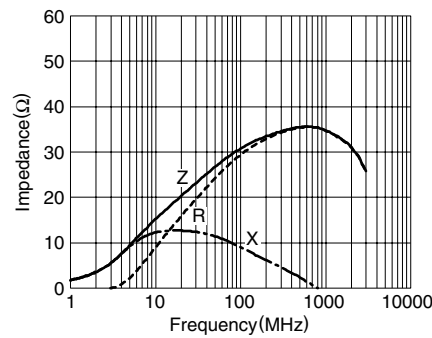
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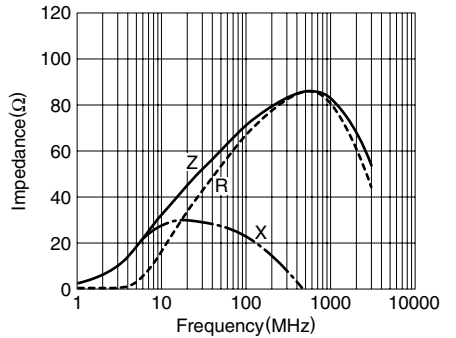
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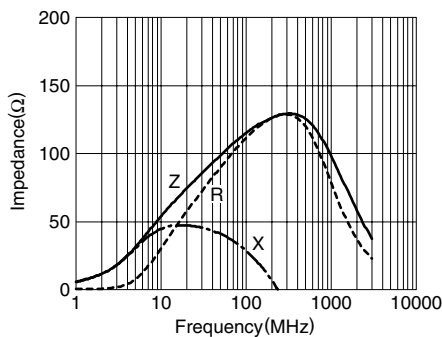
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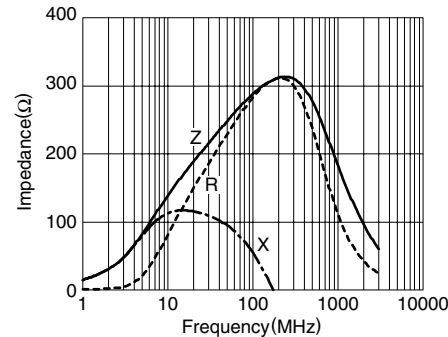
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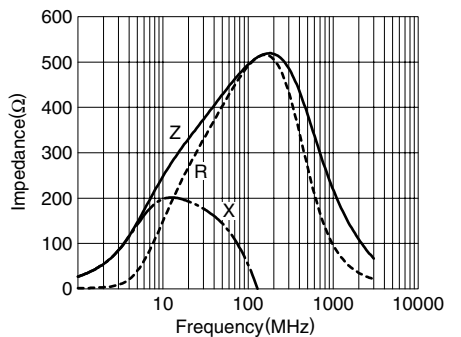
**MMZ1608R121A**



**MMZ1608R301A**



**MMZ1608R471A**

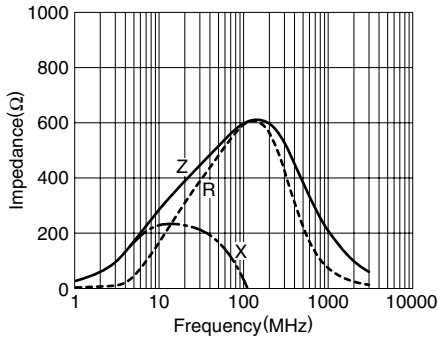


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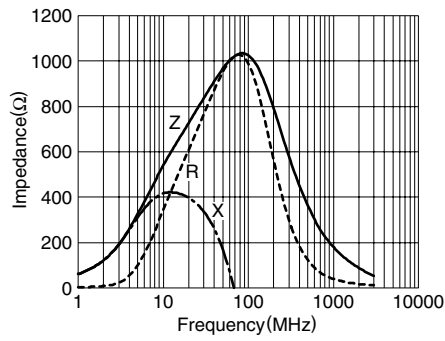
### TYPICAL ELECTRICAL CHARACTERISTICS

#### Z, X, R vs. FREQUENCY CHARACTERISTICS

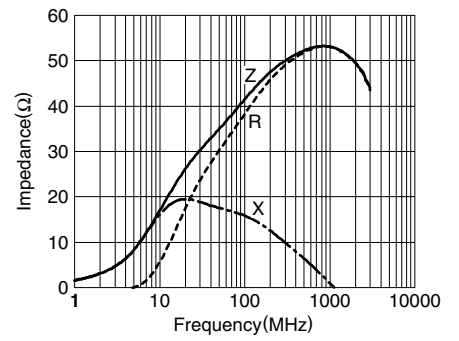
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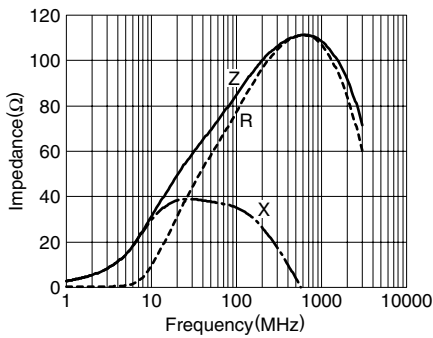
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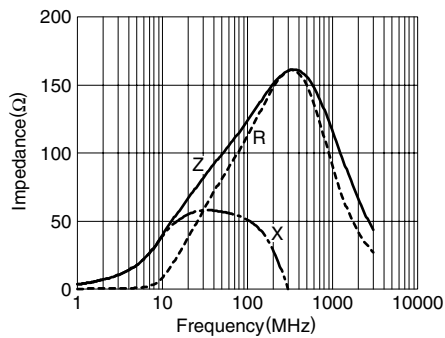
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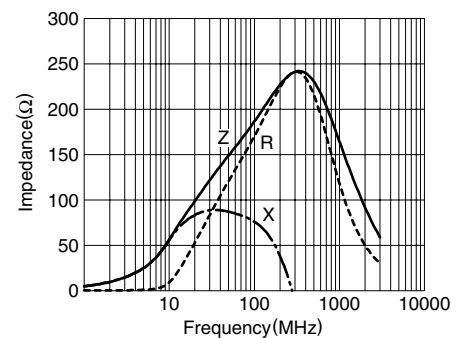
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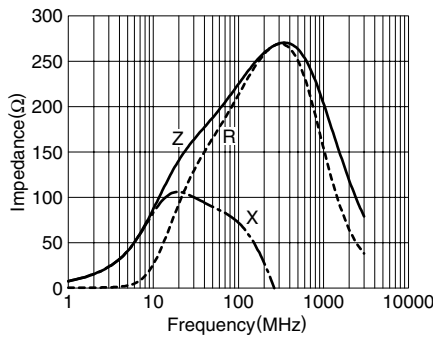
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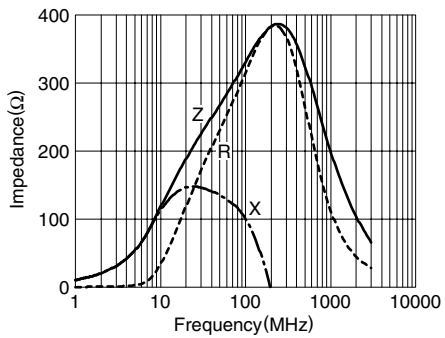
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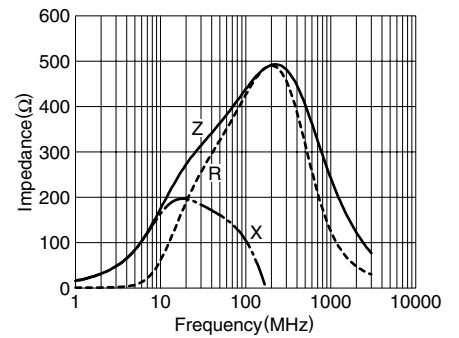
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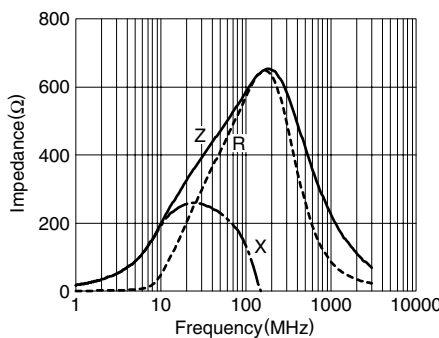
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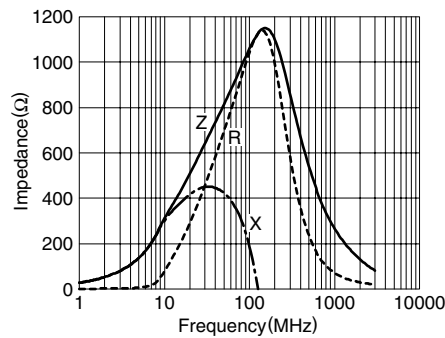
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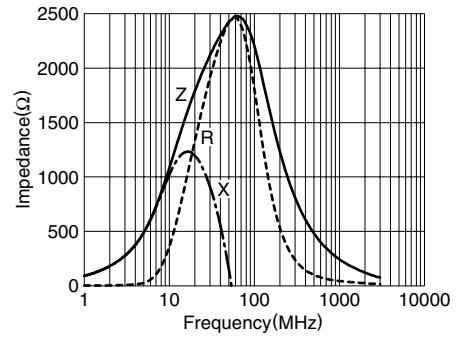
**MMZ1608S601A**



**MMZ1608S102A**



**MMZ1608S202A**

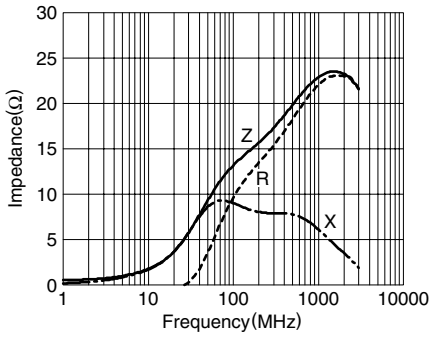


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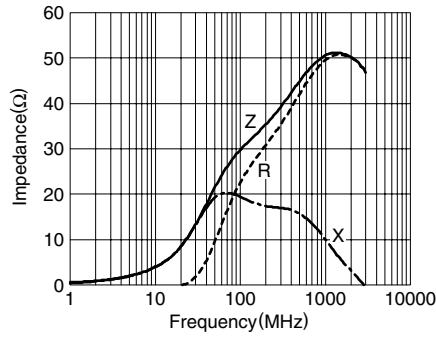
### TYPICAL ELECTRICAL CHARACTERISTICS

#### Z, X, R vs. FREQUENCY CHARACTERISTICS

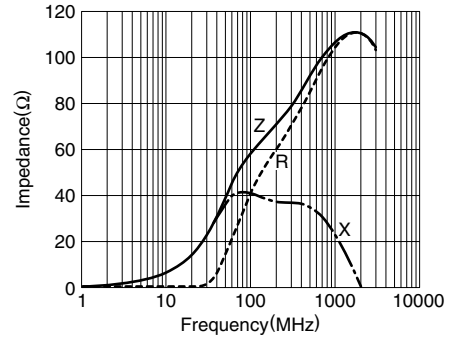
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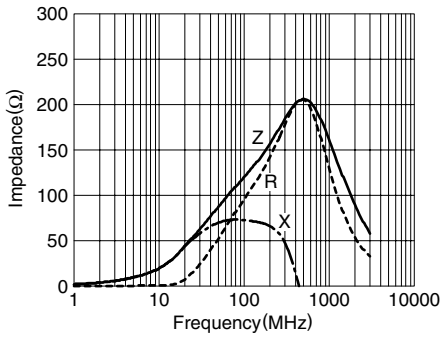
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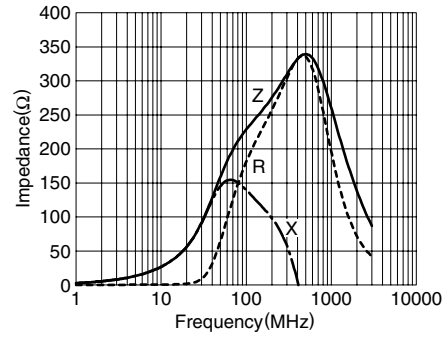
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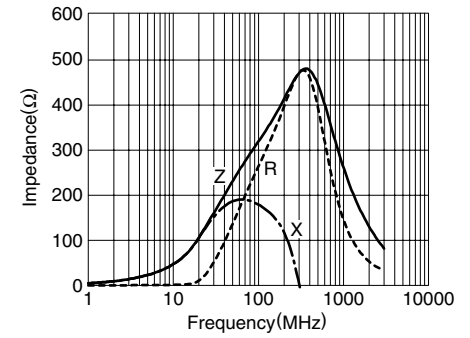
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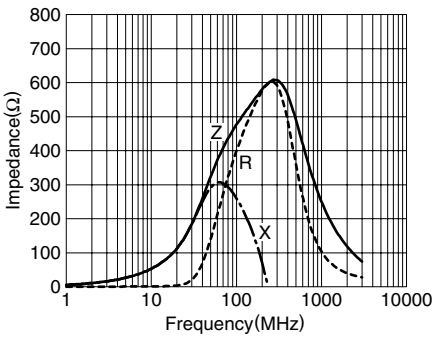
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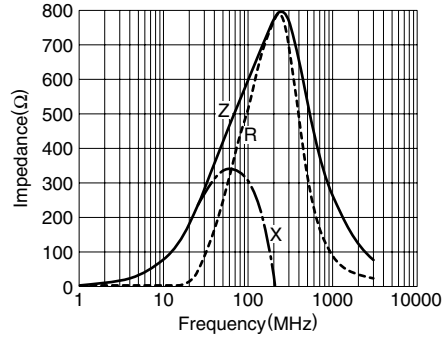
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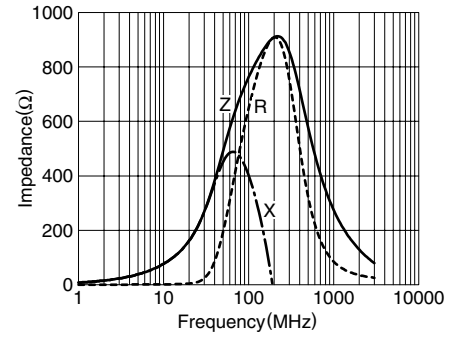
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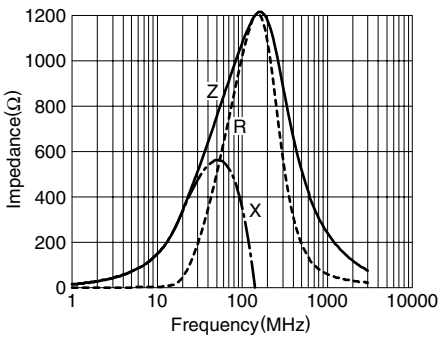
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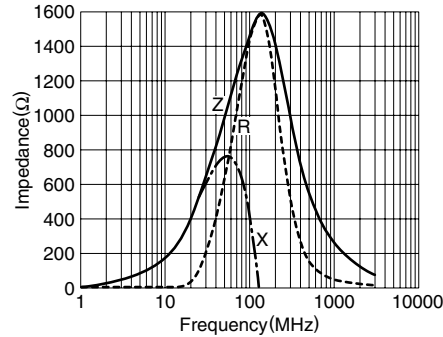
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**MMZ1608Y102B**



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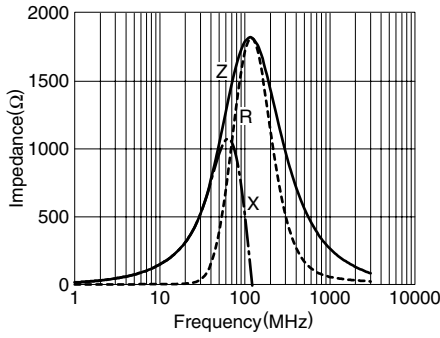


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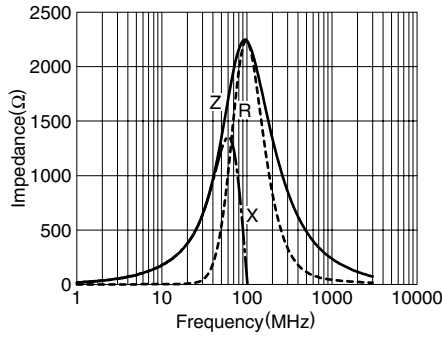
**TYPICAL ELECTRICAL CHARACTERISTICS**

**Z, X, R vs. FREQUENCY CHARACTERISTICS**

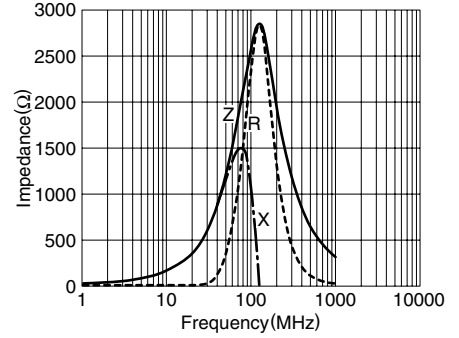
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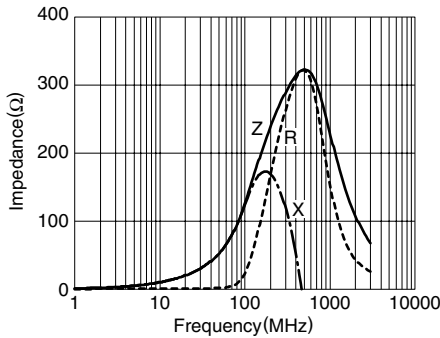
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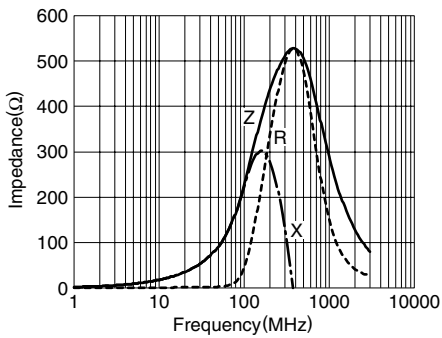
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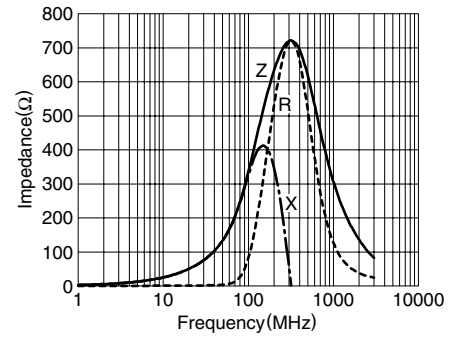
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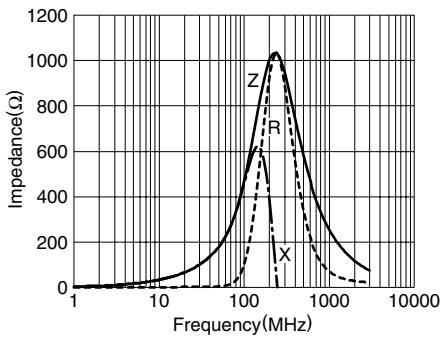
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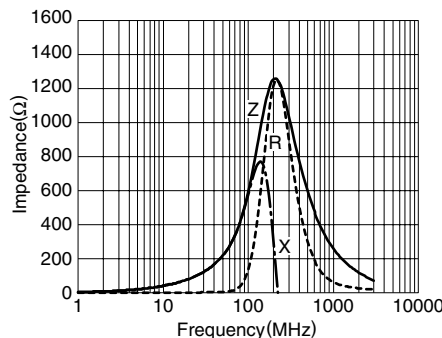
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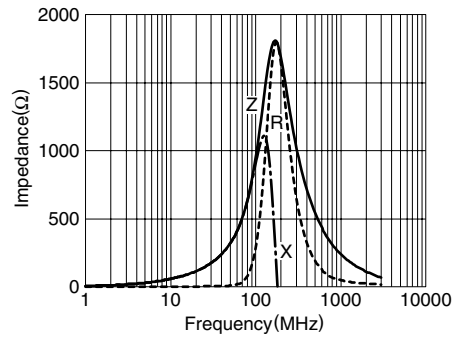
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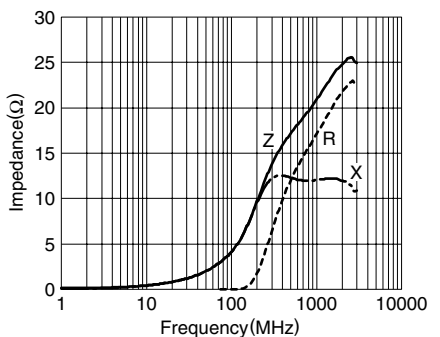
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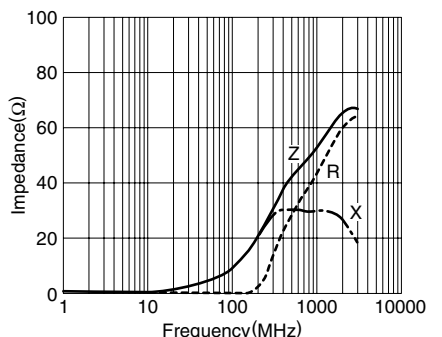
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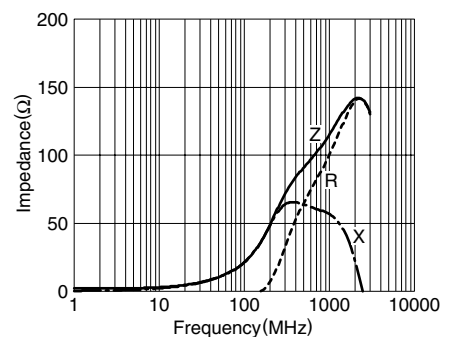
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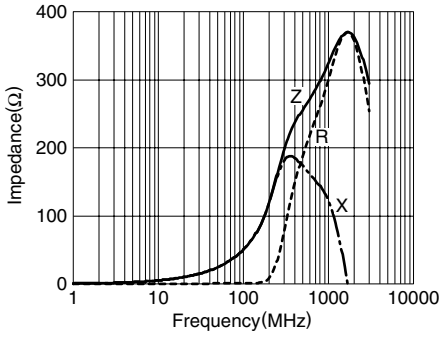


**MMZ1608D220C**

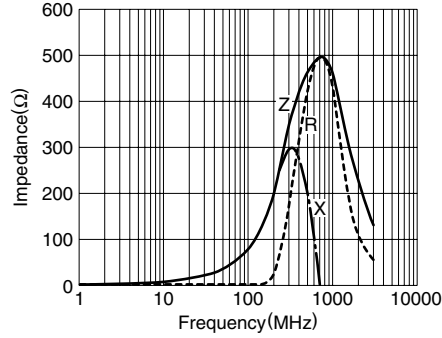


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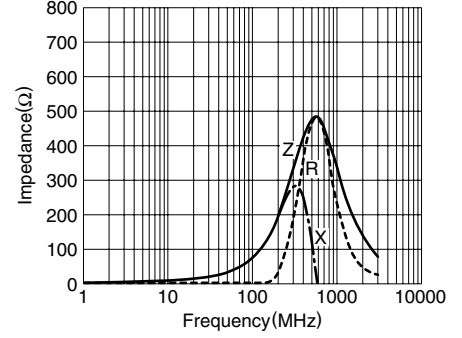
**TYPICAL ELECTRICAL CHARACTERISTICS**  
**Z, X, R vs. FREQUENCY CHARACTERISTICS**  
**MMZ1608D500C**



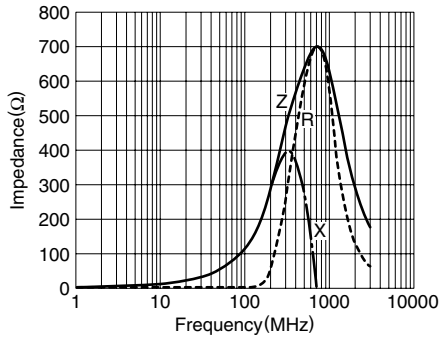
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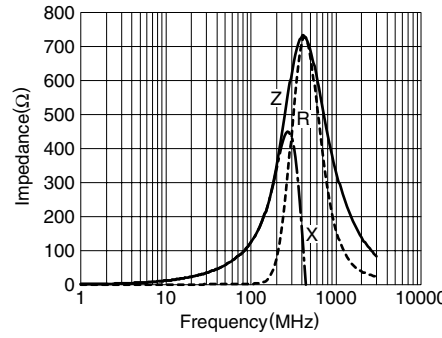
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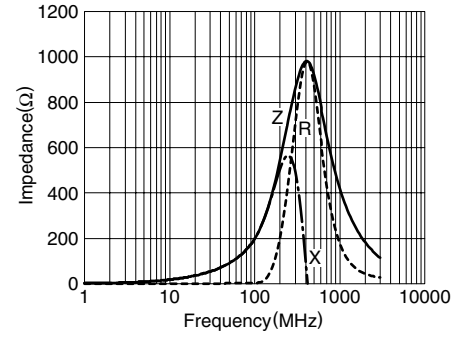
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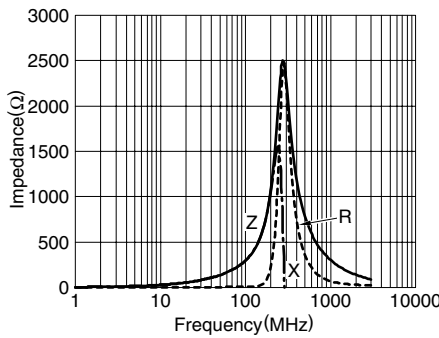
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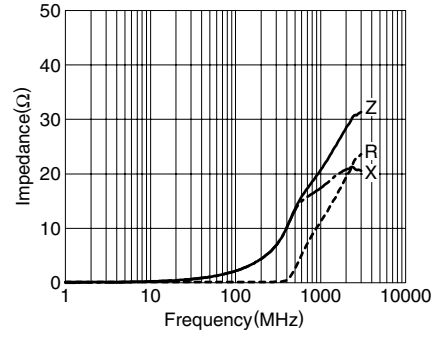
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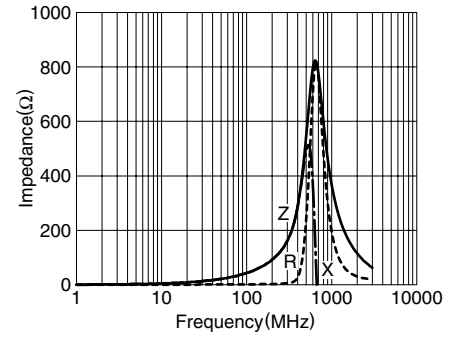
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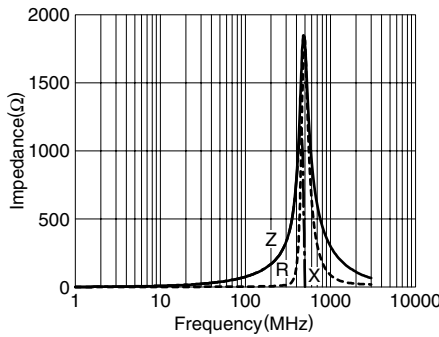
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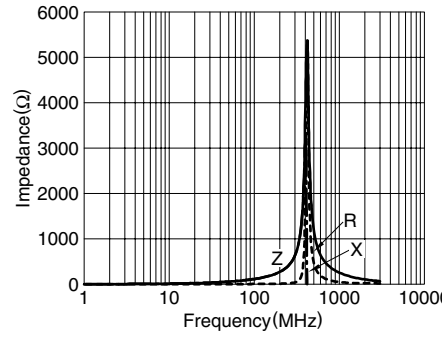
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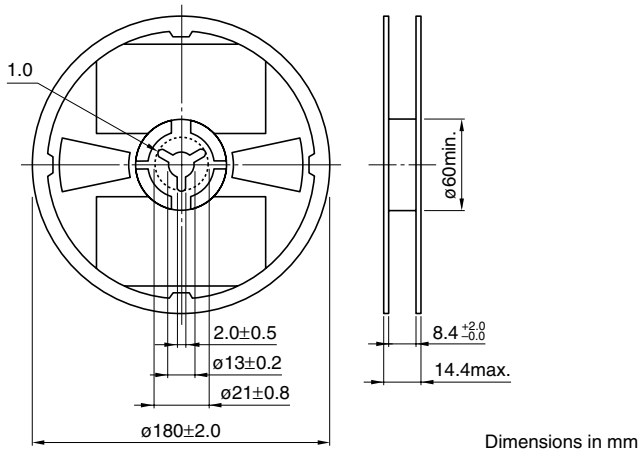


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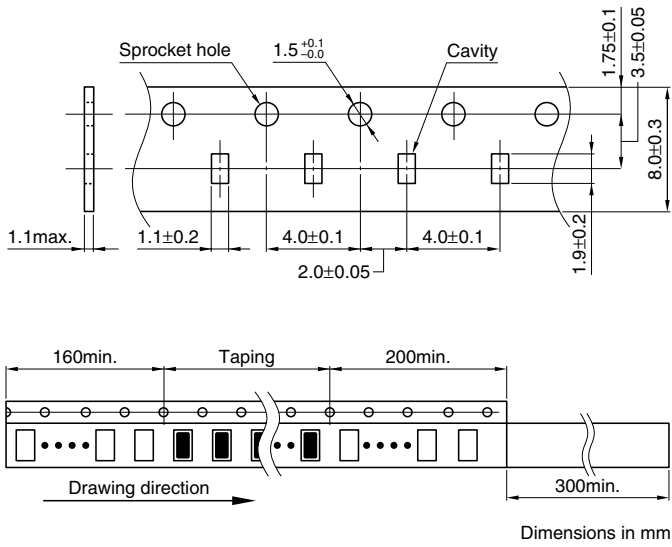


• All specifications are subject to change without notice.

**PACKAGING STYLES**  
**REEL DIMENSIONS**



**TAPE DIMENSIONS**



• All specifications are subject to change without notice.